

MOSFET

OptiMOS[™] 5 Power-Transistor, 60 V

Features

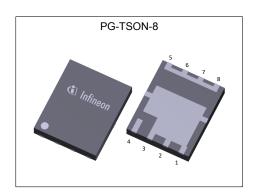
- N-channel, normal level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

table : Itay : direction and incidence							
Parameter	Value	Unit					
$V_{ extsf{DS}}$	60	V					
$R_{ extsf{DS(on),max}}$	0.9	mΩ					
I _D	445	A					
Qoss	127	nC					
Q _G	120	nC					











Type / Ordering Code	Package	Marking	Related Links
IQD009N06NM5	PG-TSON-8	00906N5	-

OptiMOS[™] 5 Power-Transistor, 60 V



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Danamatan	0	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - -	- - -	445 315 265 42	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =6 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1780	Α	<i>T</i> _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E AS	-	-	1115	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	333 3.0	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²)	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Symbol		Тур.	Max.	Ollit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.45	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for source

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.1	2.8	3.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=163\ \mu{\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.8 1.1	0.9 1.27	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =6 V, I _D =50 A
Gate resistance	R _G	-	0.5	-	Ω	-
Transconductance	g fs	-	190	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 A$

Table 5 Dynamic characteristics

Devenue	Ob. a.l	Values			11:4	Nata / Table Open distant
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	9000	12000	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	1800	2300	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	110	190	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	17	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	9	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	34	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	12	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Dovometer	Or seeds all		Values			Nata / Tank One William
Parameter	Symbol	Symbol Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	38	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	25	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	$Q_{ m gd}$	_	20	30	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	33	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	120	150	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.2	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	107	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Q _{oss}	_	127	169	nC	V _{DS} =30 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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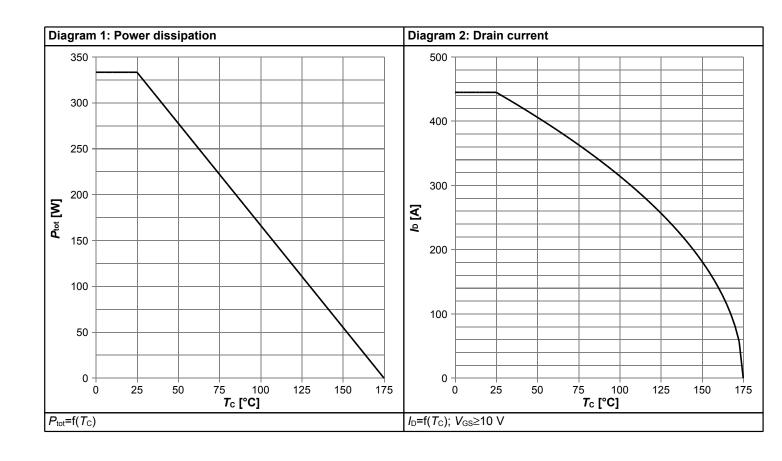


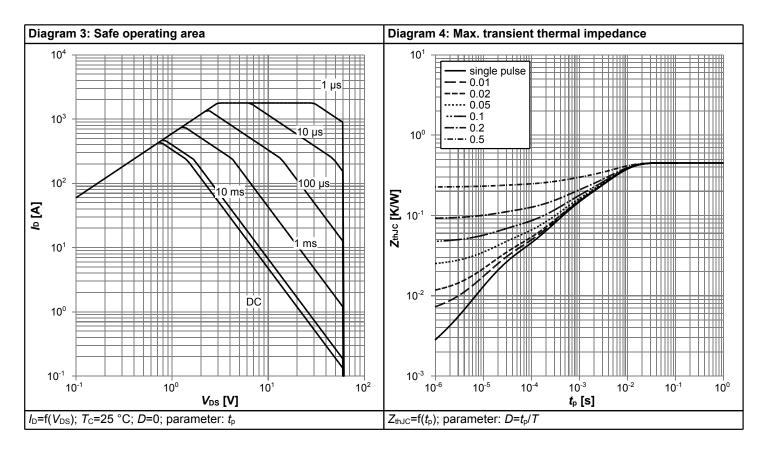
Table 7 Reverse diode

Parameter	Cymphol		Values			Nata / Tank Oan distant
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	252	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1780	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.81	1.0	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	45	90	ns	V _R =30 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	51	102	nC	V _R =30 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	28	56	ns	V _R =30 V, I _F =50 A, d <i>i</i> _F /d <i>t</i> =1000 A/μs
Reverse recovery charge ¹⁾	Qrr	-	266	532	nC	V _R =30 V, I _F =50 A, di _F /dt=1000 A/μs

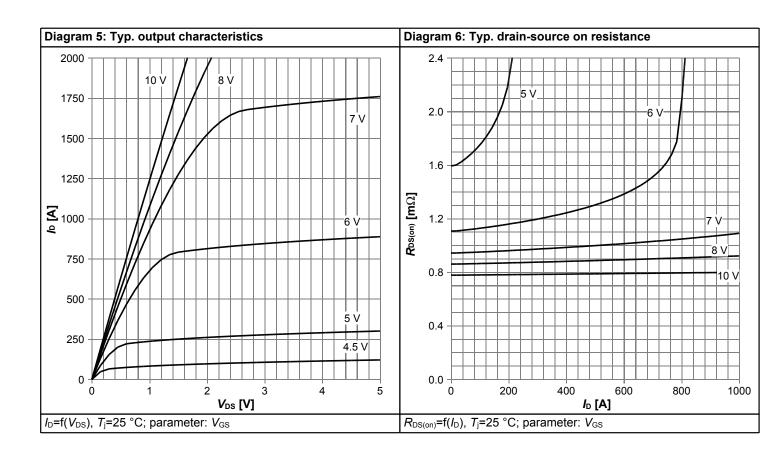


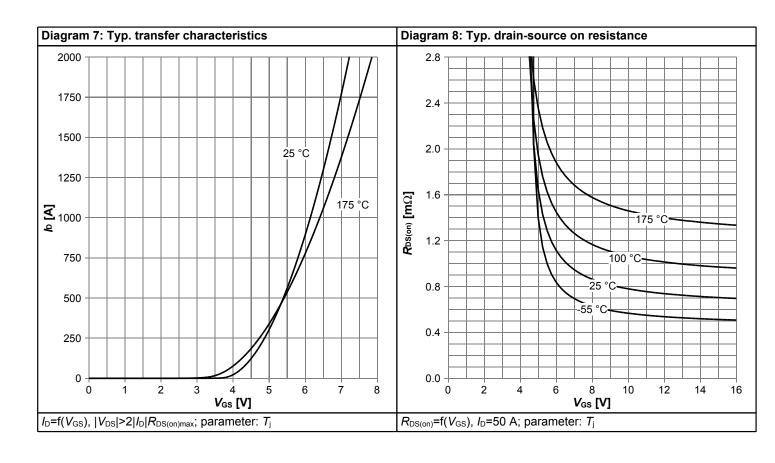
4 Electrical characteristics diagrams



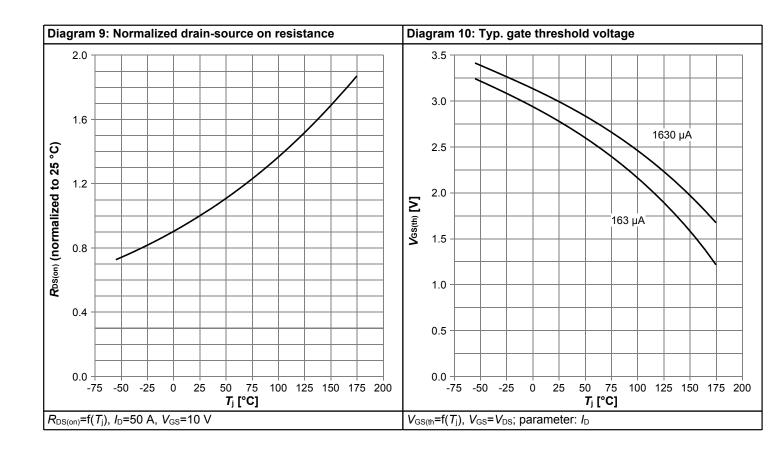


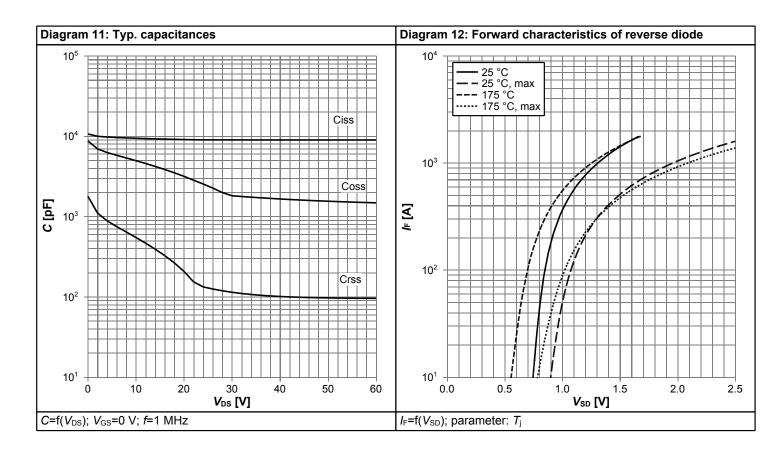




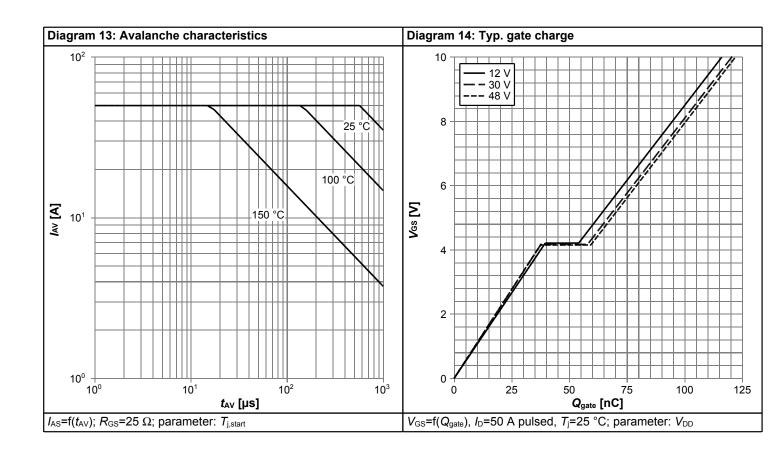


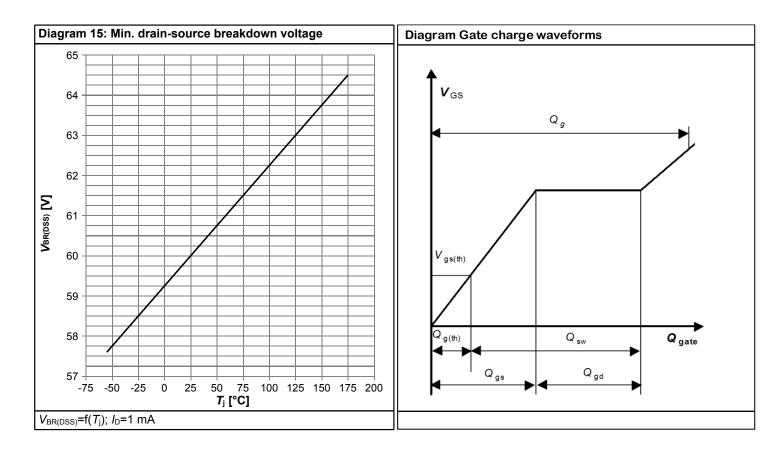














5 Package Outlines

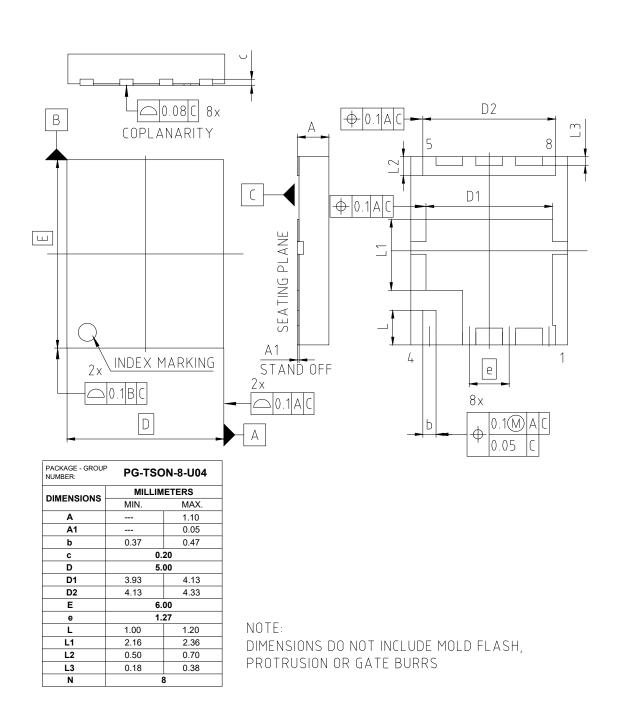


Figure 1 Outline PG-TSON-8, dimensions in mm

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Revision History

IQD009N06NM5

Revision: 2023-08-08, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2023-08-08	Release of final version

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